

US3881

Hall Latch Low Voltage & High Sensitivity

Features and Benefits

- ☐ Operating voltage range from 2.2V to 18V
- ☐ High magnetic sensitivity Multi-purpose
- ☐ CMOS technology
- ☐ Chopper-stabilized amplifier stage
- Low current consumption
- Open drain output
- ☐ Thin SOT23 3L and flat TO-92 3L both RoHS Compliant packages

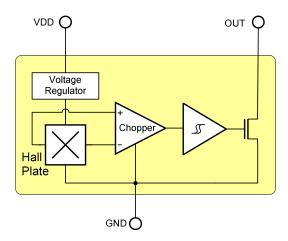
Application Examples

- Automotive, Consumer and Industrial
- Solid-state switch
- Brushless DC motor commutation
- Speed detection
- Linear position detection
- Angular position detection
- Proximity detection

Ordering Information

Part No.	Temperature Code	Package Code
US3881	E (-40 ℃ to 85 ℃)	SE (TSOT-3L)
US3881	E (-40 ℃ to 85 ℃)	UA (TO-92)
US3881	K (-40 ℃ to 125 ℃)	SE (TSOT-3L)
US3881	K (-40 ℃ to 125 ℃)	UA (TO-92)
US3881	L (-40 ℃ to 150 ℃)	SE (TSOT-3L)
US3881	L (-40 ℃ to 150 ℃)	UA (TO-92)

1 Functional Diagram



2 General Description

The Melexis US3881 is a Hall-effect latch designed in mixed signal CMOS technology.

The device integrates a voltage regulator, Hall sensor with dynamic offset cancellation system, Schmitt trigger and an open-drain output driver, all in a single package.

The low operating voltage and extended choice of temperature range make it suitable for use in automotive, industrial and consumer low voltage applications.

The devices are delivered in a Thin Small Outline Transistor (TSOT) for surface mount process and in a Plastic Single In Line (TO-92 flat) for throughhole mount.

Both 3-lead packages are RoHS compliant.





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3 Glossary of Terms

MilliTesla (mT), Gauss Units of magnetic flux density:

1mT = 10 Gauss

RoHS Restriction of Hazardous Substances

TSOT Thin Small Outline Transistor (TSOT package) – also referred with the Melexis

package code "SE"

ESD Electro-Static Discharge **BLDC Brush-Less Direct-Current**

4 Absolute Maximum Ratings

Parameter	Symbol	Value	Units
Supply Voltage	V_{DD}	20	V
Supply Current	I _{DD}	50	mA
Output Voltage	V _{OUT}	20	V
Output Current	Іоит	50	mA
Storage Temperature Range	Ts	-50 to 150	ပ္
Maximum Junction Temperature	TJ	165	°C

Table 1: Absolute maximum ratings

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute-maximumrated conditions for extended periods may affect device reliability.

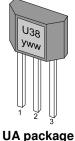
Operating Temperature Range	Symbol	Value	Units
Temperature Suffix "E"	T _A	-40 to 85	ပ္
Temperature Suffix "K"	TA	-40 to 125	°C
Temperature Suffix "L"	TA	-40 to 150	°C

5 Pin Definitions and Descriptions

SE Pin №	UA Pin №	Name	Type	Function
1	1	VDD	Supply	Supply Voltage pin
2	3	OUT	Output	Open Drain Output pin
3	2	GND	Ground	Ground pin

Table 2: Pin definitions and descriptions





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6 General Electrical Specifications

DC Operating Parameters T_A = 25°C, V_{DD} = 12V (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Supply Voltage	V_{DD}	Operating	2.2		18	V
Supply Current	I _{DD}	B < B _{RP}	1.5	2.5	5	mA
Output Saturation Voltage	V _{DSon}	$I_{OUT} = 20 \text{mA}, B > B_{OP}$		0.4	0.5	V
Output Leakage Current	loff	B < B _{RP} , V _{OUT} = 24V		0.01	10	μΑ
Output Rise Time	t _r	$R_L = 1k\Omega$, $C_L = 20pF$		0.25		μs
Output Fall Time	tf	$R_L = 1k\Omega$, $C_L = 20pF$		0.25		μs
Maximum Switching Frequency	Fsw			10		KHz
SE Package Thermal Resistance	R _{TH}	Single layer (1S) Jedec board		301		°C/W
UA Package Thermal Resistance	R _{TH}			200		°C/W

Table 3: Electrical specifications

7 Magnetic Specifications

DC Operating Parameters $T_A = 25^{\circ}C$, $V_{DD} = 2.2V$ to 18V (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Operating Point	Вор		1	5	9	mT
Release Point	B _{RP}	E spec., T _A = 85°C	-9	-5	-1	mT
Hysteresis	Внуѕт		5.5	10	12	mT
Operating Point	Вор		1	5	9	mT
Release Point	B _{RP}	L spec., T _A = 150°C	-9	-5	-1	mT
Hysteresis	B _{HYST}	7	5.5	10	12	mT

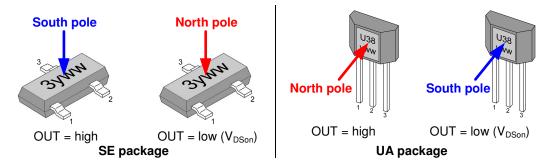
Table 4: Magnetic specifications

8 Output Behaviour versus Magnetic Pole

DC Operating Parameters $T_A = -40^{\circ}\text{C}$ to 150°C , $V_{DD} = 2.2 \text{V}$ to 18 V (unless otherwise specified)

Parameter	Test Conditions (SE)	OUT (SE)	Test Conditions (UA)	OUT (UA)
South pole	B < B _{RP}	High	B > Bop	Low
North pole	B > B _{OP}	Low	B < B _{RP}	High

Table 5: Output behaviour versus magnetic pole



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9 Detailed General Description

Based on mixed signal CMOS technology, Melexis US3881 is a Hall-effect device with high magnetic sensitivity. This multi-purpose latch suits most of the application requirements.

The chopper-stabilized amplifier uses switched capacitor techniques to suppress the offset generally observed with Hall sensors and amplifiers. The CMOS technology makes this advanced technique possible and contributes to smaller chip size and lower current consumption than bipolar technology. The small chip size is also an important factor to minimize the effect of physical stress.

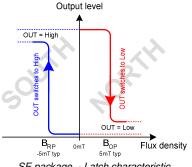
This combination results in more stable magnetic characteristics and enables faster and more precise design.

The operating voltage from 2.2V to 18V, low current consumption and large choice of operating temperature range according to "L", "K" and "E" specification make this device suitable for automotive, industrial and consumer low voltage applications.

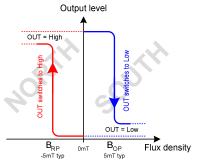
The output signal is open-drain type. Such output allows simple connectivity with TTL or CMOS logic by using a pull-up resistor tied between a pull-up voltage and the device output.

10 Unique Features

The US3881 exhibits latch magnetic switching characteristics. Therefore, it requires both south and north poles to operate properly.



SE package - Latch characteristic



UA package - Latch characteristic

The device behaves as a latch with symmetric operating and release switching points ($B_{OP}=|B_{RP}|$). This means magnetic fields with equivalent strength and opposite direction drive the output high and low.

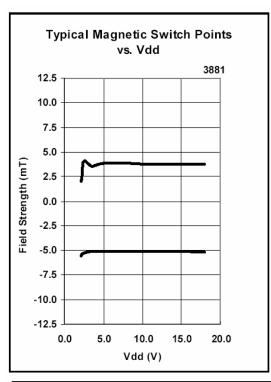
Removing the magnetic field (B→0) keeps the output in its previous state. This latching property defines the device as a magnetic memory.

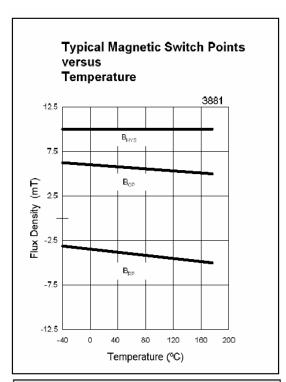
A magnetic hysteresis B_{HYST} keeps B_{OP} and B_{RP} separated by a minimal value. This hysteresis prevents output oscillation near the switching point.

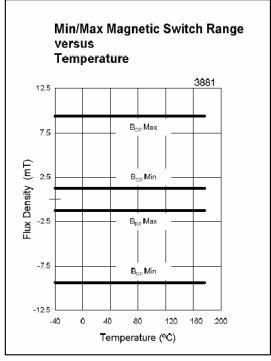
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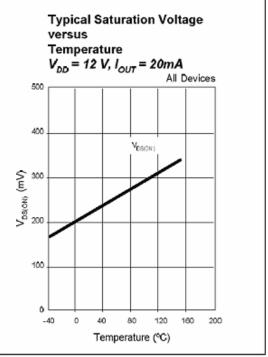


11 Performance Graphs





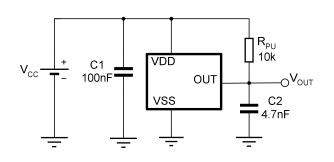




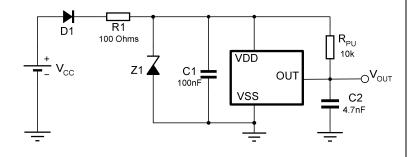


12 Application Information

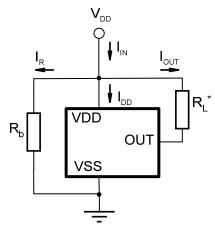
12.1 Typical Three-Wire Application Circuit



12.3 Automotive and Harsh, Noisy Environments Three-Wire Circuit



12.2 Two-Wire Circuit



Note:

With this circuit, precise ON and OFF currents can be detected using only two connecting wires.

The resistors RL and Rb can be used to bias the input current. Refer to the part specifications for limiting values.

 $B_{RP}: \quad I_{OFF} = I_R + I_{DD} = V_{DD}/R_b + I_{DD}$ B_{OP} : $I_{ON} = I_{OFF} + I_{OUT} = I_{OFF} + V_{DD}/R_L$

13 Application Comments

For proper operation, a 100nF bypass capacitor should be placed as close as possible to the device between the V_{DD} and ground pin.

For reverse voltage protection, it is recommended to connect a resistor or a diode in series with the V_{DD} pin. When using a resistor, three points are important:

- the resistor has to limit the reverse current to 50mA maximum (V_{CC} / R1 \leq 50mA)
- the resulting device supply voltage V_{DD} has to be higher than V_{DD} min ($V_{DD} = V_{CC} R1.I_{DD}$) the resistor has to withstand the power dissipated in reverse voltage condition ($P_D = V_{CC}^2 / R1$)

When using a diode, a reverse current cannot flow and the voltage drop is almost constant (≈0.7V).

Therefore, a $100\Omega/0.25W$ resistor for 5V application and a diode for higher supply voltage are recommended. Both solutions provide the required reverse voltage protection.

When a weak power supply is used or when the device is intended to be used in noisy environment, it is recommended that figure 13.3 from the Application Information section is used.

The low-pass filter formed by R1 and C1 and the zener diode Z1 bypass the disturbances or voltage spikes occurring on the device supply voltage V_{DD}. The diode D1 provides additional reverse voltage protection.

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14 Standard information regarding manufacturability of Melexis products with different soldering processes

Our products are classified and qualified regarding soldering technology, solderability and moisture sensitivity level according to following test methods:

Reflow Soldering SMD's (Surface Mount Devices)

- IPC/JEDEC J-STD-020
 Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices (classification reflow profiles according to table 5-2)
- EIA/JEDEC JESD22-A113
 Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing (reflow profiles according to table 2)

Wave Soldering SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

- EN60749-20
 - Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat
- EIA/JEDEC JESD22-B106 and EN60749-15
 Resistance to soldering temperature for through-hole mounted devices

Iron Soldering THD's (Through Hole Devices)

EN60749-15
 Resistance to soldering temperature for through-hole mounted devices

Solderability SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

 EIA/JEDEC JESD22-B102 and EN60749-21 Solderability

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

Melexis is contributing to global environmental conservation by promoting **lead free** solutions. For more information on qualifications of **RoHS** compliant products (RoHS = European directive on the Restriction Of the use of certain Hazardous Substances) please visit the quality page on our website: http://www.melexis.com/quality.asp

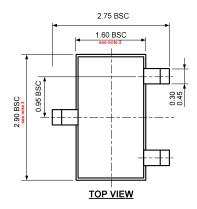
15 ESD Precautions

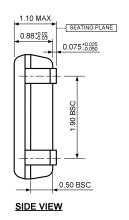
Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). Always observe Electro Static Discharge control procedures whenever handling semiconductor products.

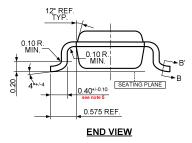


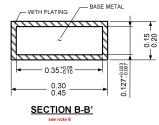
16 Package Information

16.1 SE Package (TSOT-3L)









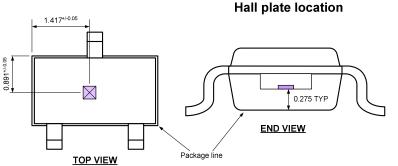
Notes:

- 1. All dimensions are in millimeters
- Outermost plastic extreme width does not include mold flash or protrusions. Mold flash and protrusions shall not exceed 0.15mm per side.
- Outermost plastic extreme length does not include mold flash or protrusions. Mold flash and protrusions shall not exceed 0.25mm per side.
- 4. The lead width dimension does not include dambar protrusion. Allowable dambar protrusion shall be 0.07mm total in excess of the lead width dimension at maximum material condition.
- 5. Dimension is the length of terminal for soldering to a substrate.
- 6. Dimension on SECTION B-B' applies to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
- 7. Formed lead shall be planar with respect to one another with 0.076mm at seating plane.

Marking:

Top side : 3yww

3 = part number (US3881) y = last digit of year ww = calendar week

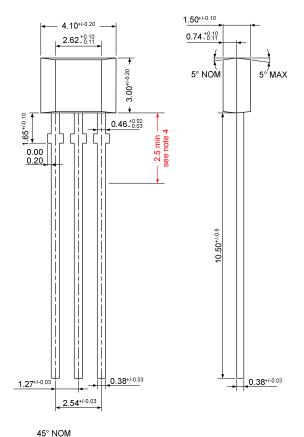


N1-4--

1. All dimensions are in millimeters



16.2 UA Package (TO-92 flat)



Notes:

- 1. All dimensions are in millimeters
- 2. Package dimension exclusive molding flash.
- The end flash shall not exceed 0.127 mm on each side.
- 4. To preserve reliability, it is recommended to have total lead length equal to 2.5mm minimum, measured from the package line.

Marking:

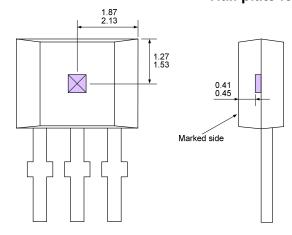
1st Line: U38 - Part number (US3881)

2nd Line : yww

y - last digit of year ww - calendar week



Hall plate location



Notes:

1. All dimensions are in millimeters

US3881 Hall Latch Low Voltage & High Sensitivity

17 Disclaimer

Devices sold by Melexis are covered by the warranty and patent indemnification provisions appearing in its Term of Sale. Melexis makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. Melexis reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with Melexis for current information. This product is intended for use in normal commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical life-support or life-sustaining equipment are specifically not recommended without additional processing by Melexis for each application.

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